

NTP30N20G-VB Datasheet

N-Channel 200 V (D-S) MOSFET

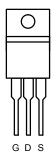
PRODUCT	SUMMARY	
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)
200	0.058at V _{GS} = 10 V	35

FEATURES

- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- · New Low Thermal Resistance Package
- · Compliant to RoHS Directive 2002/95/EC

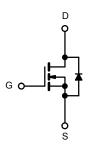






APPLICATIONS

Industrial



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S ($T_C = 25 ^{\circ}C$, unless ot	herwise noted)			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	200	V	
Gate-Source Voltage		V _{GS}	± 20]	
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	L	35		
Continuous Diain Current (1) = 175 C)	T _C = 125 °C	I _D	23	A	
Pulsed Drain Current		I _{DM}	70		
Avalanche Current		I _{AR}	35		
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	61	mJ	
Mariana Dania Dia institut	T _C = 25 °C	D	300 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	P _D	3.75	\	
Operating Junction and Storage Temperature R	ange	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.5	C/VV	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	200			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 30 \text{ V}$			± 250	nA
		V _{DS} = 200 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V, T _J = 125 °C			50	μA
		V _{DS} = 200 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	70			Α
		V _{GS} = 10 V, I _D = 20 A		0.058		
		V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.130		1
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.170		Ω
		V _{GS} = 6 V, I _D = 15 A		0.070		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		70		S
Dynamic ^b	*				· · · · · · · · · · · · · · · · · · ·	
Input Capacitance	C _{iss}	1		2690		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		200		
Reverse Transfer Capacitance	C _{rss}			110		
Total Gate Charge ^c	Qg			95	140	nC
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 45 \text{ A}$		28		
Gate-Drain Charge ^c	Q_{gd}			34		
Gate Resistance	R_{g}	f = 1 MHz		1.6		Ω
Turn-On Delay Time ^c	t _{d(on)}			22	35	
Rise Time ^c	t _r	V_{DD} = 100 V, R_{L} = 2.78 Ω		220	330	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 45 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		40	60	ns
Fall Time ^c	t _f			145	220	
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C) ^b		•		
Continuous Current	I _S				45	۸
Pulsed Current	I _{SM}				70	Α
Forward Voltage ^a	V _{SD}	I _F = 45 A, V _{GS} = 0 V		1	1.5	V
Reverse Recovery Time	t _{rr}			150	225	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 45 A, di/dt = 100 A/μs		12	18	Α
Reverse Recovery Charge	Q _{rr}			0.9	2	μC

Notes

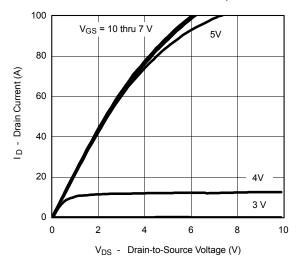
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

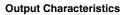
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

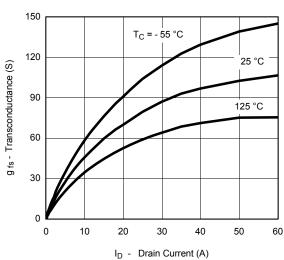
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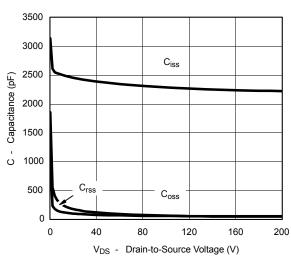
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



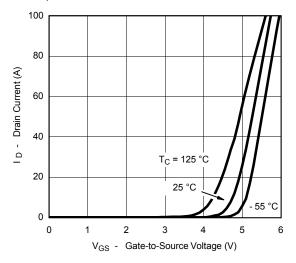




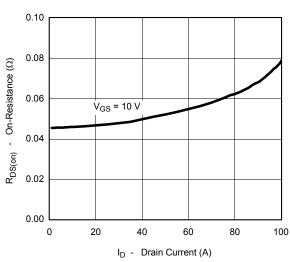
Transconductance



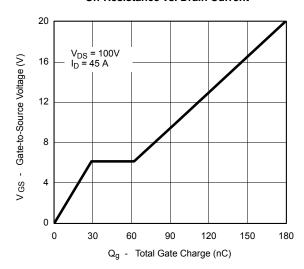
Capacitance



Transfer Characteristics



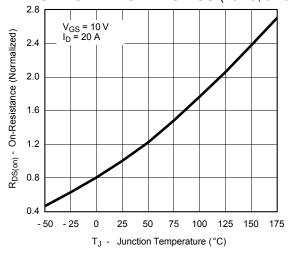
On-Resistance vs. Drain Current



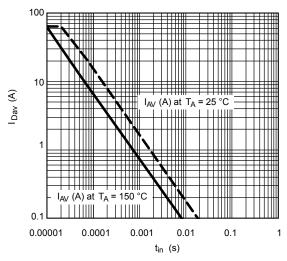
Gate Charge



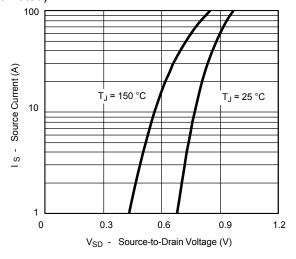
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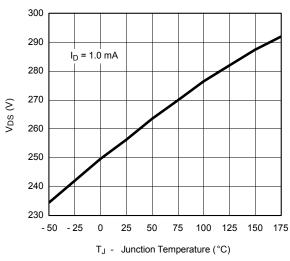
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



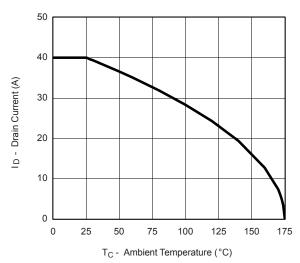
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



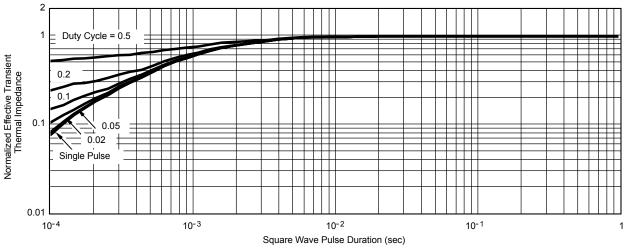
THERMAL RATINGS



100 *Limited by r_{DS(on)} 10 ID - Drain Current (A) 1 ms 10 ms, 100 ms, dc 0.1 T_C = 25 °C Single Pulse 0.01 0.001 0.1 100 1000 10 $$V_{DS}$$ - Drain-to-Source Voltage (V) $\ensuremath{^*V_{GS}}$ > minimum V_{GS} at which $r_{DS(on)}$ is specified

Maximum Avalanche and Drain Current vs. Case Temperature

Safe Operating Area, Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

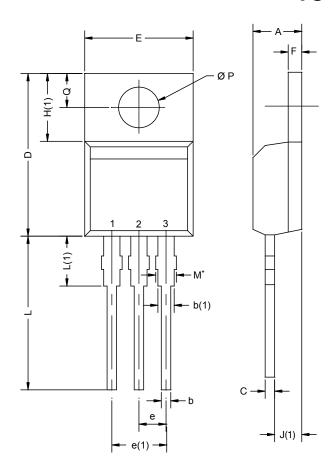
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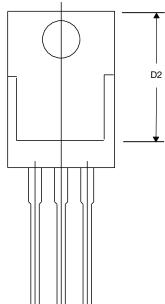
INCHES

TO-220AB



DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
D2	12.19	12.70	0.480	0.500	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
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